

WACKER® SILICONE HEAT SINK THERMALLY CONDUCTIVE SILICONE PASTE

Product description

Pure white, soft consistency, heat sink paste with marked thermal conductivity. Electrically insulating.

Application

WACKER® SILICONE HEAT SINK is used especially in semiconductor technology as a heat sink paste. Wherever it is important to have good heat transfer from a semiconductor to a cooling element, it is advisable to apply a thin coating of WACKER® SILICONE HEAT SINK. In the assembly of semiconductors, e.g. diodes, transistors and thyristors, microscopic elevations exist on the mating surfaces of the semiconductor and the cooling surface if they have not been grounded and polished. When these surfaces are placed together, a firm metal-tometal contact will result only where there are these elevations. 40 - 60 % of the surface is thus not in direct contact, depending on the roughness. This means that the hollow spaces in between these elevations are filled with air, which has relatively poor thermal conductivity.

By coating the contact surfaces with WACKER® SILICONE HEAT SINK, the thermally insulating air is replaced by the heat sink silicone paste when the semiconductor is screwed on. The thermal conductivity of WACKER® SILICONE HEAT SINK is about 20 times better than that of air. Practical experience has shown that by using WACKER® SILICONE HEAT SINK, the heat transfer resistance from the semiconductor housing to the cooling elements is reduced by 50 %.

WACKER® SILICONE HEAT SINK can be applied with a brush, spatula or by screen printing. Best results are achieved when a uniform, thin coat is applied to the mating surfaces. Paste squeezed out when the semiconductor is tightened should be removed.

Processing

For detailed information, refer to brochures on www.wacker.com.

Storage

The 'Best use before end' date of each batch is shown on the product label.

Storage beyond the date specified on the label does not necessarily mean that the product is no longer usable. In this case however, the properties required for the intended use must be checked for quality assurance reasons.

Safety notes

Comprehensive instructions are given in the corresponding Material Safety Data Sheets. They are available on request from WACKER subsidiaries or may be printed via WACKER web site http://www.wacker.com.



Product data

Typical general characteristics	Inspection Method	Value
Color		white
Density at 25 °C, at 1013 hPa	DIN 51757	2,1 g/cm ³
Consistency a) unworked penetration	DIN ISO 2137	270 - 300 1/10 mm
Consistency b) worked penetration (60 strokes)	DIN ISO 2137	300 1/10 mm
Solidifying point		approx 45 °C
Operating temperature range		- 40 to + 200 °C
Volatiles	FED-STD 791 M 321; 30h / 200 °C	max. 1,2 %
Bleeding	FED-STD 791 M 321; 30h / 200 °C	max. 0,4 %
Thermal conductivity		0,81 W/(m K)
Dielectric strength	DIN 53481	10 kV/mm
Permittivity (50 Hz)	IEC 60250	3,5 ɛr
Dissipation factor (50 Hz)	IEC 60250	9 x 10 ⁻³
Insoluble in		water, methanol, ethanol glycerol, glycol
Soluble or dispersible in (except filler)		methylene chloride, benzine, white spirit, petroleum ether, toluene, kerosene, ethyl acetate etc.

These figures are only intended as a guide and should not be used in preparing specifications.

The data presented in this leaflet are in accordance with the present state of our knowledge, but do not absolve the user from carefully checking all supplies immediately on receipt. We reserve the right to alter product constants within the scope of technical progress or new developments. The recommendations made in this leaflet should be checked by preliminary trials because of conditions during processing over which we have no control, especially where other companies' raw materials are also being used. The recommendations do not absolve the user from the obligation of investigating the possibility of infringement of third parties' rights and, if necessary, clarifying the position. Recommendations for use do not constitute a warranty, either express or implied, of the fitness or suitability of the products for a particular purpose. The management system has been certified according to DIN EN ISO 9001 and DIN EN ISO 14001

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